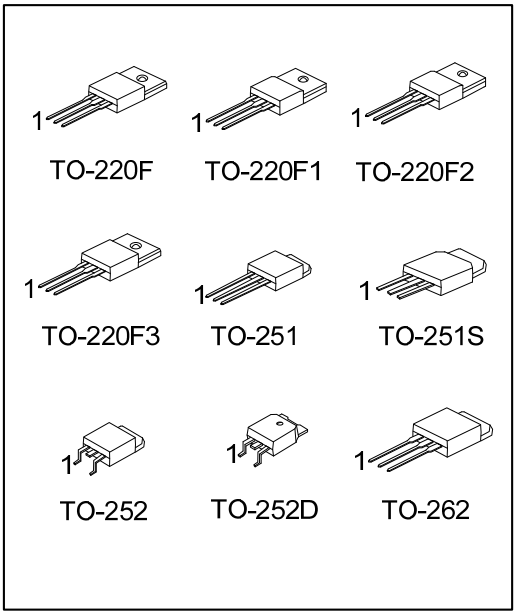
4N70K-TA

Power MOSFET

4.0A, 700V N-CHANNEL POWER MOSFET



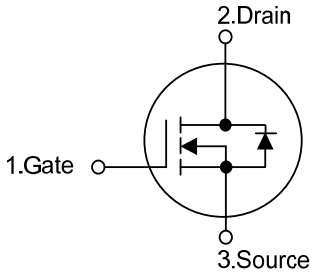
■ DESCRIPTION

The UTC **4N70K-TA** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche. This high speed switching power MOSFET is usually used in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

■ FEATURES

* $R_{DS(ON)}$ < 3.5Ω @ V_{GS} = 10 V, I_D = 2 A
* Fast Switching Capability
* Avalanche Energy Specified
* Improved dv/dt Capability, High Ruggedness

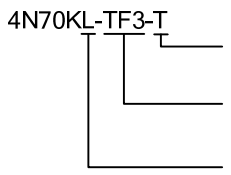
■ SYMBOL



■ ORDERING INFORMATION

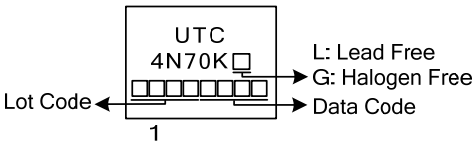
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
4N70KL-TF3-T	4N70KG-TF3-T	TO-220F	G	D	S	Tube
4N70KL-TF1-T	4N70KG-TF1-T	TO-220F1	G	D	S	Tube
4N70KL-TF2-T	4N70KG-TF2-T	TO-220F2	G	D	S	Tube
4N70KL-TF3T-T	4N70KG-TF3T-T	TO-220F3	G	D	S	Tube
4N70KL-TM3-T	4N70KG-TM3-T	TO-251	G	D	S	Tube
4N70KL-TMS-T	4N70KG-TMS-T	TO-251S	G	D	S	Tube
4N70KL-TN3-R	4N70KG-TN3-R	TO-252	G	D	S	Tape Reel
4N70KL-TND-R	4N70KG-TND-R	TO-252D	G	D	S	Tape Reel
4N70KL-T2Q-T	4N70KG-T2Q-T	TO-262	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



(1) T: Tube, R: Tape Reel
(2) TF3: TO-220F, TF1: TO-220F1, TF1: TO-220F2
TF3T: TO-220F3, TM3: TO-251, TMS: TO-251S
TN3: TO-252, TND: TO-252D, T2Q: TO-262
(3) L: Lead Free, G: Halogen Free and Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I_{AR}	4.0	A
Drain Current	Continuous	I_D	4.0	A
	Pulsed (Note 2)	I_{DM}	17.6	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	216	mJ
	Repetitive (Note 2)	E_{AR}	10.6	mJ
Power Dissipation	TO-220F/TO-220F1/ TO-220F2/TO-220F3	P_D	36	W
	TO-251/TO-251S TO-252/TO-252D		49	W
	TO-262		106	W
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Junction Temperature		T_J	+150	°C
Operating Temperature		T_{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating : Pulse width limited by maximum junction temperature
3. L = 27mH, I_{AS} = 4 A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C
4. I_{SD}≤ 4.0A, di/dt ≤200A/μs, V_{DD}≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

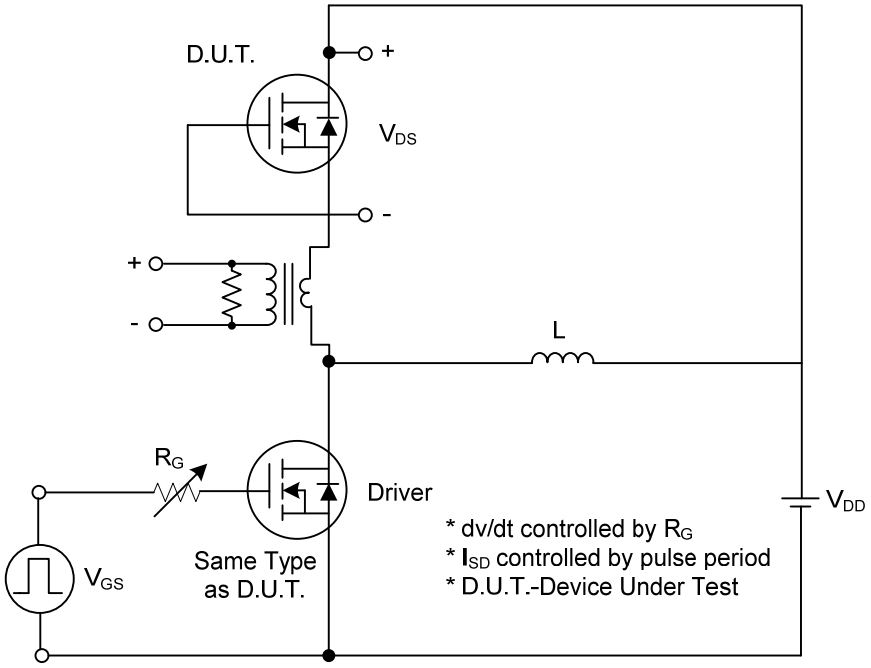
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F/TO-220F1/ TO-220F2/TO-220F3 TO-262	θ_{JA}	62.5	°C/W
	TO-251/TO-251S TO-252/TO-252D		110	°C/W
Junction to Case	TO-220F/TO-220F1 TO-220F3	θ_{JC}	3.47	°C/W
	TO-220F2		3.28	°C/W
	TO-251/TO-251S TO-252/TO-252D		2.55	°C/W
	TO-262		1.18	°C/W

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

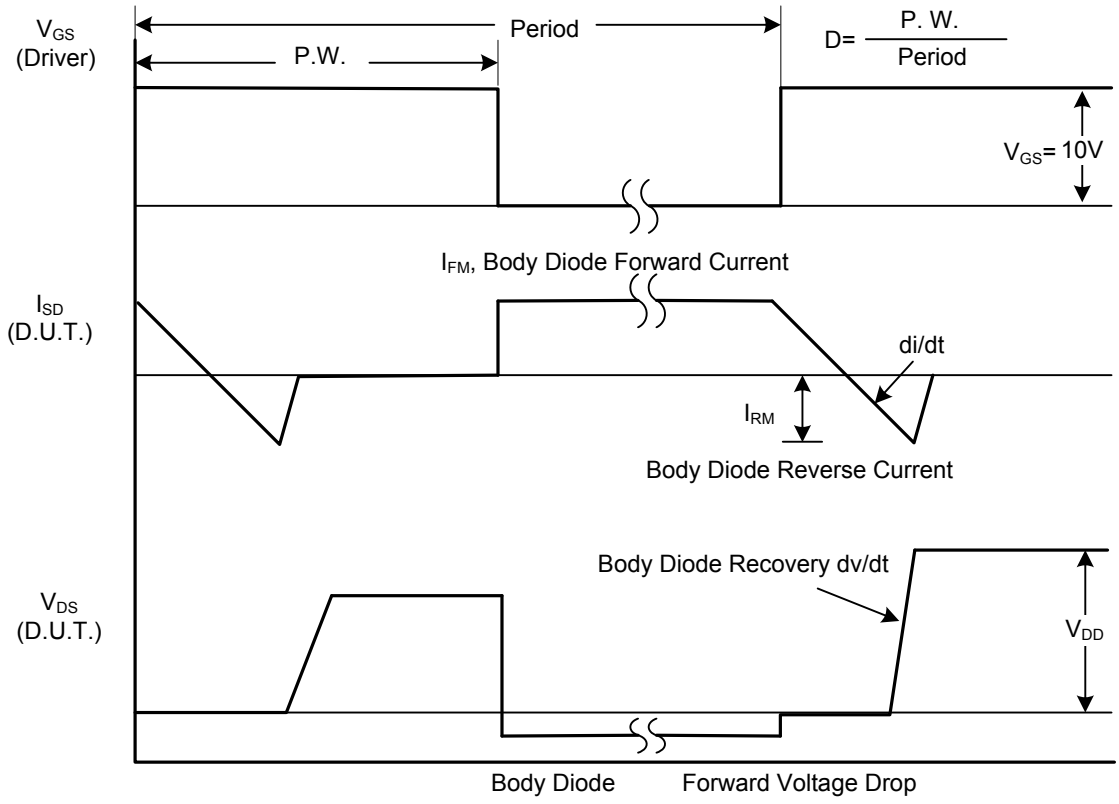
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS} = 0 V, I_D = 250 μA	700			V
Drain-Source Leakage Current		I_{DSS}	V_{DS} = 700 V, V_{GS} = 0 V			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS} = 30 V, V_{DS} = 0 V			100	nA
	Reverse		V_{GS} = -30 V, V_{DS} = 0 V			-100	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_J$	I_D = 250μA, Referenced to 25°C		0.6		V/°C
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS} = V_{GS}, I_D = 250 μA	2.0		4.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS} = 10 V, I_D = 2 A			3.5	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{DS} = 25 V, V_{GS} = 0 V, f = 1MHz		660	760	pF
Output Capacitance		C_{OSS}			48	90	pF
Reverse Transfer Capacitance		C_{RSS}			5	11	pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time		$t_{D(ON)}$	V_{DD} = 30V, I_D = 0.5A, R_G = 25Ω (Note 1, 2)		45		ns
Turn-On Rise Time		t_R			32		ns
Turn-Off Delay Time		$t_{D(OFF)}$			80		ns
Turn-Off Fall Time		t_F			24		ns
Total Gate Charge		Q_G	V_{DS}= 50V, I_D= 1.3A, V_{GS}= 10 V (Note 1, 2)		37		nC
Gate-Source Charge		Q_{GS}			4.8		nC
Gate-Drain Charge		Q_{GD}			6.0		nC
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage		V_{SD}	V_{GS} = 0 V, I_S = 4.0 A			1.4	V
Maximum Continuous Drain-Source Diode Forward Current		I_S				4.0	A
Maximum Pulsed Drain-Source Diode Forward Current		I_{SM}				17.6	A

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

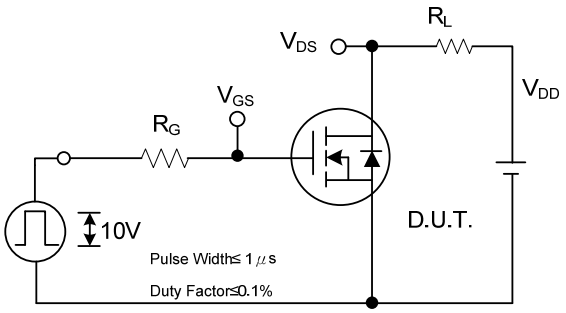


Peak Diode Recovery dv/dt Test Circuit

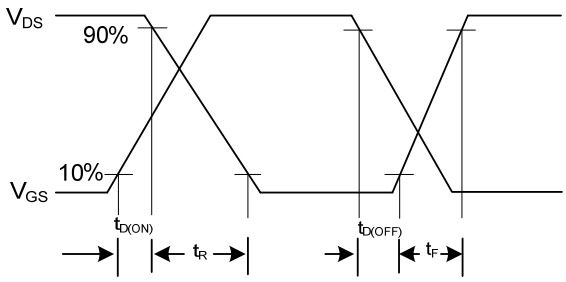


Peak Diode Recovery dv/dt Waveforms

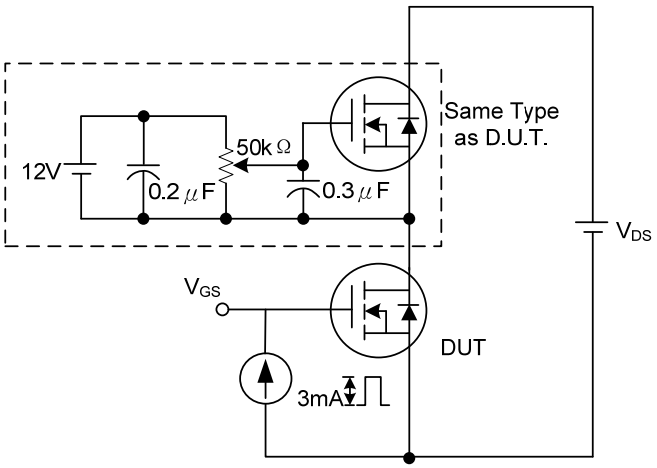
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



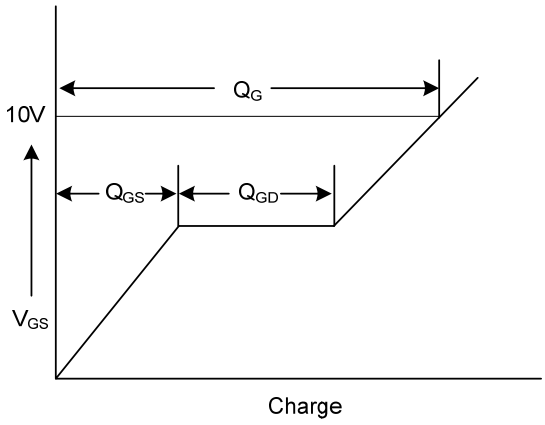
Switching Test Circuit



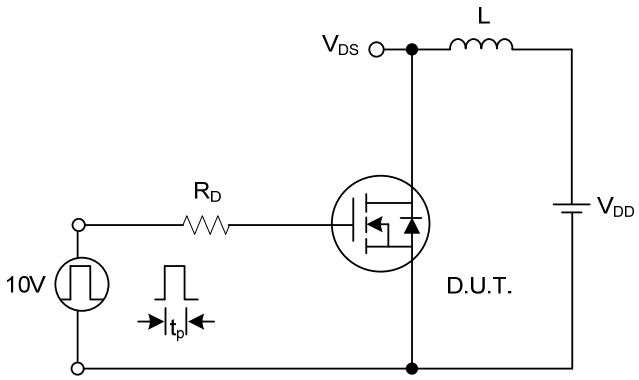
Switching Waveforms



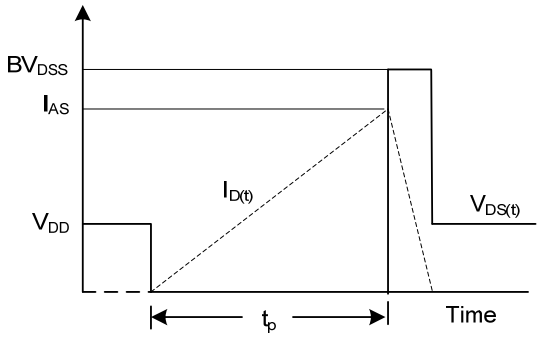
Gate Charge Test Circuit



Gate Charge Waveform



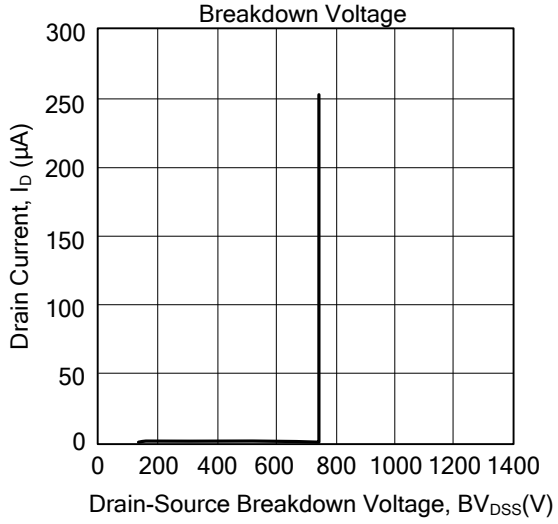
Unclamped Inductive Switching Test Circuit



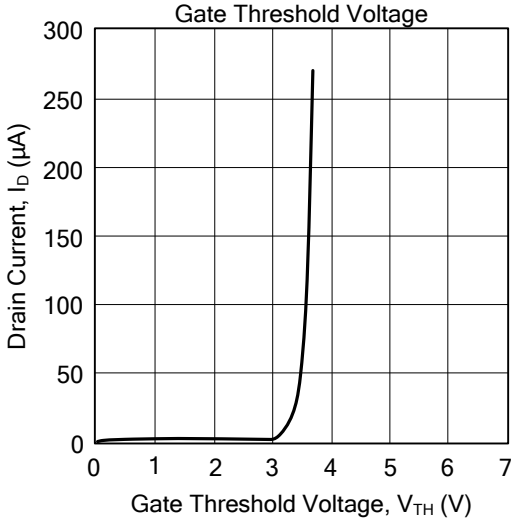
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

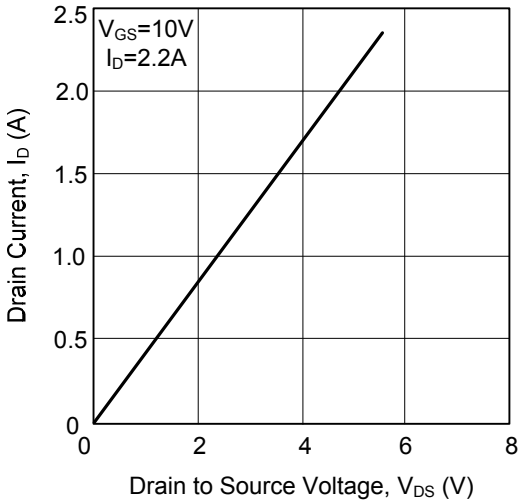
Drain Current vs. Drain-Source Breakdown Voltage



Drain Current vs. Gate Threshold Voltage



Drain-Source On-State Resistance Characteristics



Continuous Drain-Source Diode Forward Current vs. Source to Drain Voltage